

SURFACE MOUNT DISPLAY

APDC02-41SURKWA HYPER RED

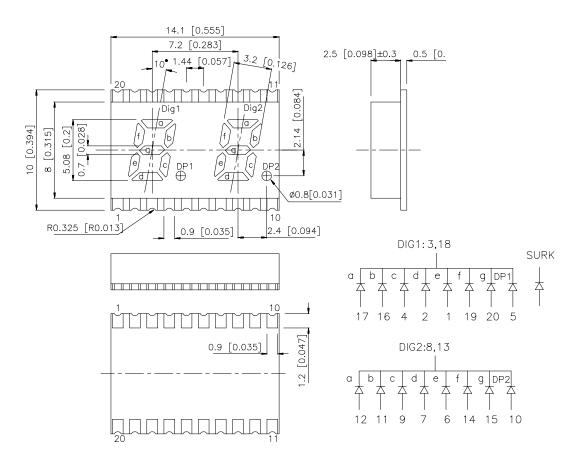
Features

- •0.2INCH DIGIT HEIGHT.
- •LOW CURRENT OPERATION.
- •EXCELLENT CHARACTER APPEARANCE.
- •I.C. COMPATIBLE.
- •MECHANICALLY RUGGED.
- •GRAY FACE, WHITE SEGMENT.
- •PACKAGE: 600PCS/REEL.

Description

The Hyper Red source color devices are made with DH InGaAIP on GaAs substrate Light Emitting Diode.

Package Dimensions& Internal Circuit Diagram



Notes

- 1. All dimensions are in millimeters (inches), Tolerance is $\pm 0.25 (0.01")$ unless otherwise noted.
- 2. Specifications are subject to change without notice.

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APPROVED: J. Lu CHECKED: Joe Lee DRAWN: F.Y.YUAN



Selection Guide

Part No.	Dice	Dice Lens Type		i cd)) mA	Description	
			Min. Typ.			
APDC02-41SURKWA	HYPER RED(InGaAIP)	WHITE DIFFUSED	8000	30400	Common Cathode,Rt. Hand Decimal	

Electrical / Optical Characteristics at T_A=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red	650		nm	I F =20mA
λD	Dominate Wavelength	Hyper Red	635		nm	I F =20mA
Δλ1/2	Spectral Line Half-width	Hyper Red	28		nm	I F =20mA
С	Capacitance	Hyper Red	35		pF	VF=0V;f=1MHz
VF	Forward Voltage	Hyper Red	1.95	2.5	V	I F =20mA
IR	Reverse Current	Hyper Red		10	uA	V _R = 5V

Absolute Maximum Ratings at T_A=25°C

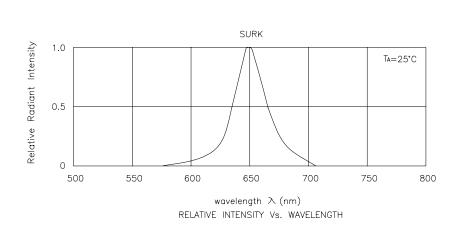
Parameter	Hyper Red	Units
Power dissipation	170	mW
DC Forward Current	30	mA
Peak Forward Current [1]	185	mA
Reverse Voltage	5	V
Operating/Storage Temperature	-40°C To +85°C	

Note

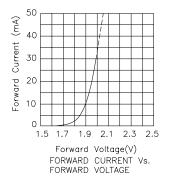
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

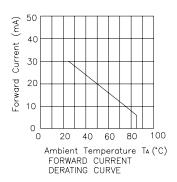
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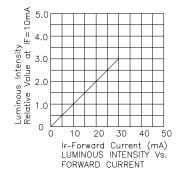


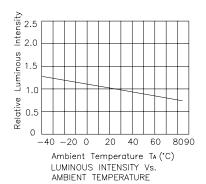


Hyper Red APDC02-41SURKWA







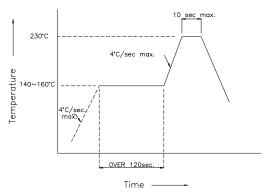


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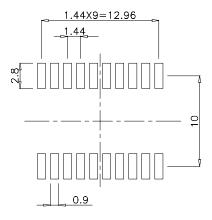
Kingbright

APDC02-41SURKWA SMT Reflow Soldering Instructions

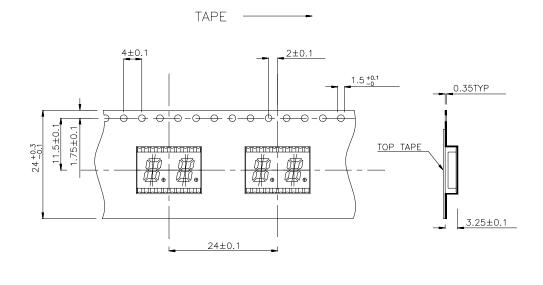
Number of reflow process shall be less than 2 times and cooling process to normal temperature is required between first and second soldering process.



Recommended Soldering Pattern (Units:mm)



Tape Specifications (Units:mm)



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